2/15/02

03-06-2002

Docket No. JCLA8456

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JC979 U.S. PTO
10/078211
02/15/02

Form 1595
1-31-92

RECORDATION F

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Patent and Trademark Office

PATENTS ONLY

To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Jao-Chin Cheng, Chih-Peng Fan, David C. H. Cheng	2. Name/address of receiving Party(ies): Unimicron Technology Corp. No. 38, Hsing Pong Rd., Kwei-San Industrial Exended Zone, Taoyuan, Taiwan, R.O.C.
3. Nature of conveyance: ☒ Assignment ☐ Merger ☐ Security Agreement ☐Other ☐ Change of Name ☐ Reassignment	Add'l names of receiving parties Attached? ☐ Yes ☒ No
4. Date(s) of execution: January 24, 2002.	

5. Application number(s) or patent number(s):

If this documents is being filed together with a new application, the execution date of the application is January 24, 2002.

A. Patent Application No. (s) Additional numbers attached	B. Patent No. (s) 10/078211 ? ☐ Yes ☒ No
6. Name and address of party to whom Correspondence concerning document should be mailed: J.C. Patents, Inc. 4 Venture, Suite 250 Irvine, CA 92618 (949) 660-0761	7. Total No. of applications and patents involved: ONE(1) 8. Total fee (37 CFR §3.41): $40.00 ☒ Enclosed ☐ Charge to Acct. No. ______ 9. Total number of pages, including Cover sheet, attachments and document 3.

DO NOT USE THIS SPACE

10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jiawei Huang	Jiawei Huang	2/15/2002
Name of Person Signing	Signature	Date

Registration No. 43,330

03/05/2002 LMUELLER 00000022 10078211
01 FC:581 40.00 OP

ASSIGNMENT

WHEREAS, 1. Jao-Chin Cheng 2. Chih-Peng Fan
3. David C. H. Cheng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FORMING IC PACKAGE HAVING DOWNWARD-FACING CHIP CAVITY**

[ ] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Unimicron Technology Corp.
of
No. 38, Shing-Bang Rd., Kuei San Industrial Zone, Taoyuan Shih, Taoyuan
Hsien Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Jao-chin Cheng
Signature:
Sole or First Joint Inventor: Jao-Chin Cheng

Jan 24 2002
Date:

Chih-Peng Fan
Signature:
Second Joint Inventor (if any): Chih-Peng Fan

Jan. 24. 2002
Date:

David C. H. Cheng
Signature:
Third Joint Inventor (if any): David C. H. Cheng

Jan 24. 2002
Date: